# Memory Module Specifications



## KVR1066D3S8N7/2G

2GB 1Rx8 256M x 64-Bit PC3-8500 CL7 240-Pin DIMM

**Important Information:** The module defined in this data sheet is one of several configurations available under this part number. While all configurations are compatible, the DRAM combination and/or the module height may vary from what is described here.

#### **DESCRIPTION**

This document describes ValueRAM's 256M x 64-bit (2GB) DDR3-1066 CL7 SDRAM (Synchronous DRAM), 1Rx8 memory module, based on eight 256M x 8-bit DDR3-1066 FBGA components. The SPD is programmed to JEDEC standard latency DDR3-1066 timing of 7-7-7 at 1.5V. This 240-pin DIMM uses gold contact fingers. The electrical and mechanical specifications are as follows:

#### **FEATURES**

- JEDEC standard 1.5V (1.425V ~1.575V) Power Supply
- VDDQ = 1.5V (1.425V ~ 1.575V)
- 533MHz fCK for 1066Mb/sec/pin
- · 8 independent internal bank
- Programmable CAS Latency: 9, 8, 7, 6
- Programmable Additive Latency: 0, CL 2, or CL 1 clock
- Programmable CAS Write Latency(CWL) = 6 (DDR3-1066)
- 8-bit pre-fetch
- Burst Length: 8 (Interleave without any limit, sequential with starting address "000" only), 4 with tCCD = 4 which does not allow seamless read or write [either on the fly using A12 or MRS]
- Bi-directional Differential Data Strobe
- Internal(self) calibration: Internal self calibration through ZQ pin (RZQ: 240 ohm ± 1%)
- On Die Termination using ODT pin
- Average Refresh Period 7.8us at lower than TCASE 85°C, 3.9us at 85°C < TCASE ≤ 95°C</li>
- Asynchronous Reset
- PCB Height: 1.18" (30mm), single sided component

### **SPECIFICATIONS**

| 7 cycles          |
|-------------------|
| 50.63ns (min.)    |
| 160ns (min.)      |
| 37.5ns (min.)     |
| 0.725 W*          |
| 94 V - 0          |
| 0° C to 85° C     |
| -55° C to +100° C |
|                   |

<sup>\*</sup>Power will vary depending on the SDRAM used.

Continued >>

# **MODULE DIMENSIONS:**





